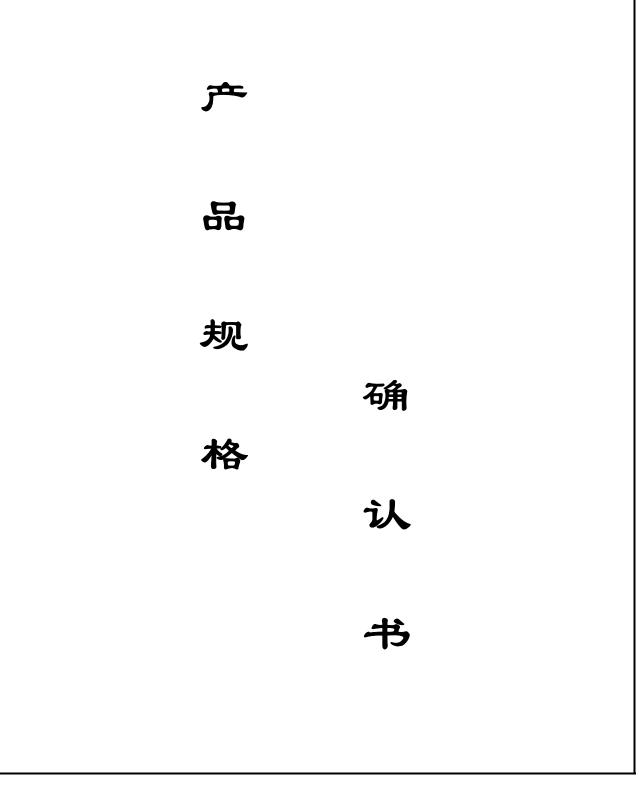
US1XW SERIES

SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER



Download from alldatasheet.com

US1AW THRU US1MW

SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER

REVERSE VOLTAGE: FORWARD CURRENT:

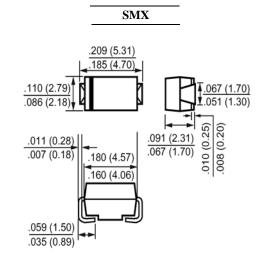
50 to 1000 VOLTS 1.0 AMPERE

FEATURES

- · Plastic package has Underwriters Laboratory
- Flammability Classification 94V-O
- \cdot For surface mounted applications
- · Low profile package
- \cdot Easy pick and place
- · Built-in strain relief
- \cdot Ultrafast recovery times for high efficiency
- \cdot High temperature soldering : 250°C /10 seconds at terminals

MECHANICAL DATA

Case: Molded plastic, SMX Terminals: Solder plated, solderable per MIL-STD-750, method 2026 guaranteed Polarity: Color band denotes cathode end Packaging: 12mm tape per EIA STD RS-481 Weight: 0.002 ounce, 0.064 gram



EK.

HORNBY ELECTRONIC

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Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, $60H_Z$, resistive or inductive load. For capacitive load, derate current by 20%.

	Symbols	US1AW	US1BW	US1DW	US1GW	US1JW	US1KW	US1MW	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T _L =100°C	I _(AV)				1.0				Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I _{FSM}	I _{FSM} 30							Amp
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 1.0A	V _F		1.0		1.3		1.7		Volts
Maximum Reverse Current at T _A =25°C	5.0								
at Rated DC Blocking Voltage $T_A=100$ °C	IR	I _R 100							μАтр
Typical Junction Capacitance (Note 1)	CJ	17						pF	
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	30							°C/W
Maximum Reverse Recovery Time (Note 3)	T _{RR}	50 75					nS		
Operating Junction Temperature Range	T _J	-55 to +150							ç
Storage Temperature Range	Tstg	-55 to +150						ပံ	

NOTES:

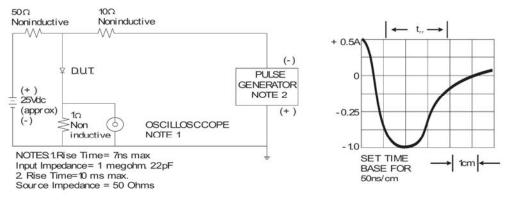
1- Measured at 1 $\ensuremath{\mathsf{MH}}\xspace_Z$ and applied reverse voltage of 4.0 VDC.

2- Thermal resistance from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas

3- Reverse Recovery Test Conditions: I_F =.5A, I_R =1A, I_{RR} =.25A.

RATINGS AND CHARACTERISTIC CURVES

RATING AND CHARACTERISTIC CURVES





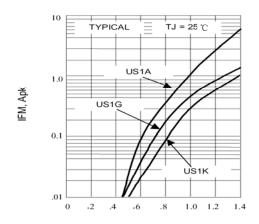


Fig. 2-FORWARD CHARACTERISTICS

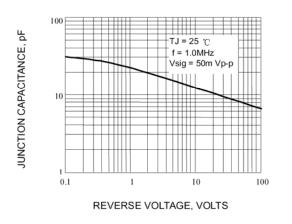
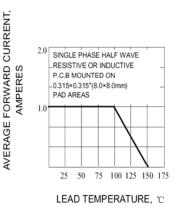


Fig. 4-TYPICAL JUNCTION CAPACITANCE





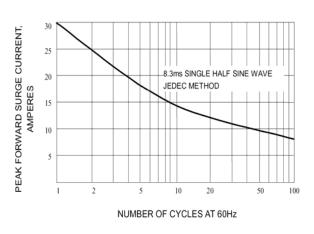


Fig. 5-PEAK FORWARD SURGE CURRENT